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- Inputs Are TTL-Voltage Compatible
- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- High-Current Outputs Drive up to 15 LSTTL Loads
- Package Options Include Plastic Small-Outline (DW) and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

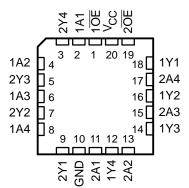
These octal buffers and line drivers are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The 'HCT240 are organized as two 4-bit buffers/drivers with separate output-enable (\overline{OE}) inputs. When \overline{OE} is low, the device passes inverted data from the A inputs to the Y outputs. When \overline{OE} is high, the outputs are in the high-impedance state.

The SN54HCT240 is characterized for operation over the full military temperature range of -55° C to 125°C. The SN74HCT240 is characterized for operation from -40° C to 85° C.

SN54HCT240 J OR W PACKAGE
SN74HCT240 DW OR N PACKAGE
(TOP VIEW)

	(,
1 <mark>0E</mark> [1A1 [1 2	20 V <u>CC</u> 19 20E
2Y4 [1A2 [2Y3 [4	18] 1Y1 17] 2A4 16] 1Y2
1A3 [2Y2 [6	15 2A3
1A4 [2Y1 [GND]	8 9 10	13 2A2 12 1Y4 11 2A1
	10	

SN54HCT240 . . . FK PACKAGE (TOP VIEW)



FUNCTION TABLE (each buffer/driver)

(cacil bullel/dilvel)										
INP	JTS	OUTPUT								
OE	Α	Y								
L	Н	L								
L	L	Н								
Н	Х	Z								



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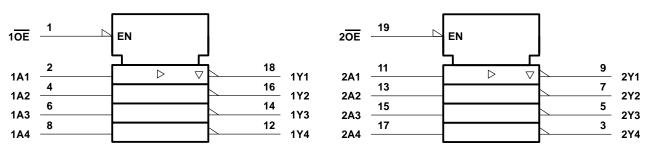
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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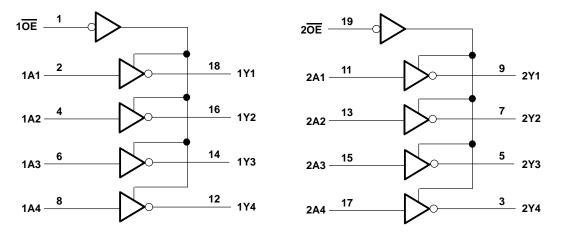
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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range[‡]

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1)	±20 mA
Output clamp current, I_{OK} (V _O < 0 or V _O > V _{CC}) (see Note 1)	±20 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	±35 mA
Continuous current through V _{CC} or GND	±70 mA
Package thermal impedance, θ_{JA} (see Note 2): DW package	97°C/W
N package	67°C/W
Storage temperature range, T _{stg}	. −65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.



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recommended operating conditions

			SN	54HCT2	40	SN	74HCT2	40	UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	$V_{CC} = 4.5 V \text{ to } 5.5 V$	2			2			V
VIL	Low-level input voltage	$V_{CC} = 4.5 V \text{ to } 5.5 V$	0		0.8	0		0.8	V
VI	Input voltage		0		VCC	0		VCC	V
Vo	Output voltage		0		VCC	0		VCC	V
tt	Input transition (rise and fall) time		0		500	0		500	ns
ТА	Operating free-air temperature		-55		125	-40		85	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		Vee	Т	T _A = 25°C		SN54HCT240		SN74HCT240		UNIT
PARAMETER	TEST CO	NDITION3	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
Vau	$\lambda = \lambda + \sigma \lambda$	I _{OH} = -20 μA	4.5 V	4.4	4.499		4.4		4.4		V
∨он	$V_{I} = V_{IH} \text{ or } V_{IL}$	I _{OH} =6 mA	4.5 V	3.98	4.3		3.7		3.84		v
Ve	$V_{I} = V_{IH} \text{ or } V_{IL}$	I _{OL} = 20 μA	4.5 V		0.001	0.1		0.1		0.1	V
VOL		I _{OL} = 6 mA	4.5 V		0.17	0.26		0.4		0.33	v
li	VI = VCC or 0		5.5 V		±0.1	±100		±1000		±1000	nA
IOZ	$V_{O} = V_{CC} \text{ or } 0,$	$V_I = V_{IH} \text{ or } V_{IL}$	5.5 V		±0.01	±0.5		±10		±5	μA
ICC	$V_I = V_{CC} \text{ or } 0,$	IO = 0	5.5 V			8		160		80	μA
∆lcc‡	One input at 0.5 V of Other inputs at 0 or		5.5 V		1.4	2.4		3		2.9	mA
Ci			4.5 V to 5.5 V		3	10		10		10	pF

[†] This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V_{CC}.

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	Vee	Тį	₄ = 25°C	;	SN54H	CT240	SN74H	CT240	UNIT
PARAMETER	(INPUT)	IC VCC MIN Y 4.5 V 5.5 V Y 4.5 V 4.5 V	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
· .	А	V	4.5 V		13	25		37		32	200
^t pd	A	Y	5.5 V		12	23		33		29	ns
+	5	Y	4.5 V		21	35		53		44	ns
ten	OE		I	5.5 V		19	32		48		40
+	OE	Y	4.5 V		19	35		53		44	ns
^t dis	OE	Ι	5.5 V		18	32		48		40	115
.		V	4.5 V		8	12		18		15	
t		I	5.5 V		7	11		16		14	ns



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switching characteristics over recommended operating free-air temperature range, $C_L = 150 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	Vee	Т	λ = 25°C	;	SN54H	CT240	SN74H	CT240	UNIT
FARAMETER	(INPUT)	(OUTPUT)	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
÷ .	٨	Y	4.5 V		20	42		63		53	20
^t pd	A	T	5.5 V		19	38		56		48	ns
+		v	4.5 V		25	52		79		65	20
ten	ŌĒ	T	5.5 V		22	47		71		59	ns
		v	4.5 V		17	42		63		53	20
tt		ř	5.5 V		14	38		57		48	ns

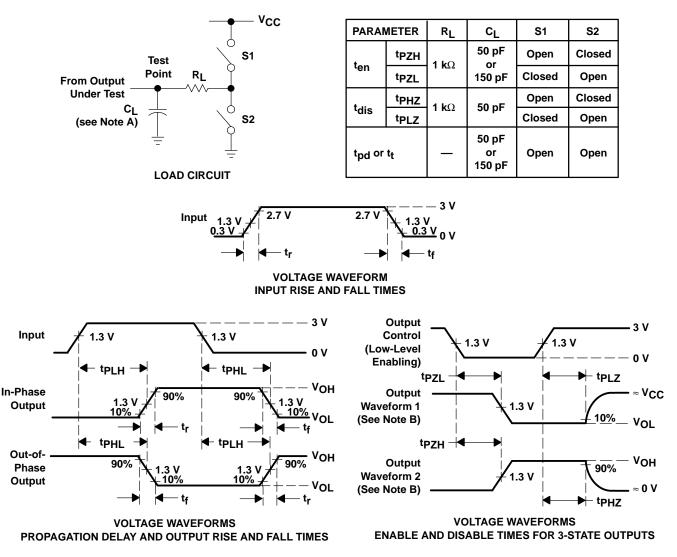
operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
Cpd	Power dissipation capacitance per buffer/driver	No load	40	рF



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PARAMETER MEASUREMENT INFORMATION



- NOTES: A. CL includes probe and test-fixture capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f = 6 ns, t_f = 6 ns.
 - D. The outputs are measured one at a time with one input transition per measurement.
 - E. tpl 7 and tpHZ are the same as tdis.
 - F. tp71 and tp7H are the same as ten.
 - G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



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